

VUTS010R055NA

Datasheet

VMDSEMI



VUTS010R055NA

General Description

Symbol

V _{(BR)DSS}	R _{DS(ON)_max}	ID
100V	5.5mΩ@10V	200A

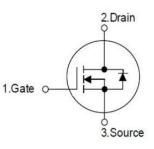
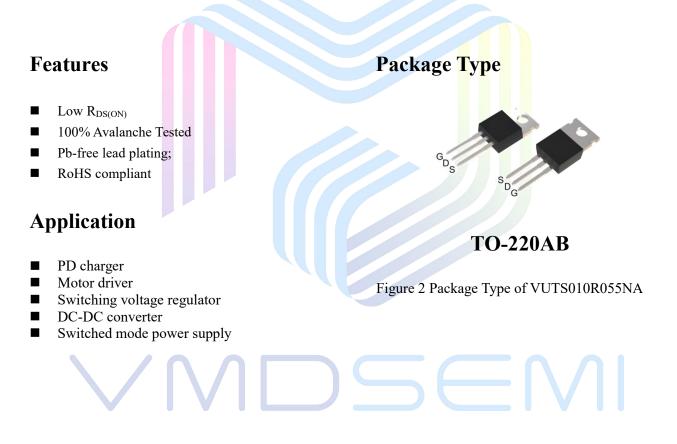


Figure 1 Symbol of VUTS010R055NA



Ordering Information

Product Name	Package			
VUTS010R055NA	TO-220AB			



VUTS010R055NA

Absolute Maximum Ratings (T_A= 25 °C, unless otherwise specified)

Parameter	Symbol	Rating	Unit	
Drain-Source Voltage		V _{DSS}	100	V
Gate-Source Voltage		V _{GSS}	±25	V
Continuous Drain Current	$T_{C}=25^{\circ}C$	т	200	A
Continuous Drain Current	T _C =100°C	- I _D	142	A
Pulsed Drain Current ^{Note 2}	$T_C=25^{\circ}C$	I _{D.pulse}	800	A
Continuous Diode Forward Current	$T_C=25^{\circ}C$	Is	200	A
Continuous Drain Current	$T_A=25^{\circ}C$	т	15	A
Continuous Drain Current	$T_A=70^{\circ}C$	- I _{DSM}	12	A
Max Power Dissipation	$T_{\rm C}=25^{\rm o}{\rm C}$	PD	375	W
Max Power Dissipation ^{Note 3}	T _A =25°C	P _{DSM}	2	W
Avalanche Energy, Single Pulse ^{Note 4}		Eas	900	mJ
Operation and storage temperature		T _J ,T _{STG}	- <mark>5</mark> 5 to 175	°C

Thermal Resistance

Parameter	Symbol	Min	Тур	Max	Unit
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$		0.4	0.5	°C/W
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$		62.5	75	C/W

VNDSENI



VUTS010R055NA

Parameter		Symbol	Test Conditions	Min	Тур	Max	Unit
Statistic Characteristics		•			-		
Drain-Source Breakdown Voltage		BV _{DSS}	V _{GS} =0V, I _D =250uA	100			V
Zero Gate Voltage Drain Current		- I _{DSS}	V _{DS} =100V, V _{GS} =0V			1	uA
Zero Gate Voltage Drain Current T_J = 125 °C			V _{DS} =100V, V _{GS} =0V			100	uA
Gate-Body Leakage Current	Forward	I _{GSSF}	$V_{GS}=25V, V_{DS}=0V$			100	nA
	Reverse	I _{GSSR}	I _{GSSR} V _{GS} =-25V, V _{DS} =0V			-100	
Gate Threshold Voltage		V _{GS(TH)}	V _{DS} =V _{GS} , I _D =250uA	2.4	3	3.6	V
Drain-Source On-Resistance ^{Note1}		- R _{DS(ON)}			4.5	5.5	mΩ
Drain-Source On-Resistance ^{Note1} T _J = 100 °C			$V_{GS}=10V, I_{D}=80A$		6.5		
Gate resistance		R _G	f=1 MHz, Open drain	0.2	2.3	5	Ω
Dynamic Characteristics							
Input Capacitance		CISS	V _{DS} =30V	11065	14755	19625	pF
Output Capacitance		Coss	V _{GS} =0V	500	665	885	pF
Reverse Transfer Capacitance		C _{RSS}	f=1MHz	370	495	660	pF
Turn-on Delay Time		t _{d(on)}	V _{DS} =50V		35		
Rise Time		tr	I _D =40A		67		
Turn-off Delay Time		t _{d(off)}	$R_G=3\Omega$		128		ns
Fall Time		t _f	V _{GS} =10V		64		
Gate Charge Characteristics							
Gate to Source Charge	ate to Source Charge		V _{GS} =10V		59	78	
Gate to Drain Charge		Q _{gd}	$V_{DS}=50V$		60	90	nC
Gate Charge Total		Qg	I _D =40A		232	309	
Reverse Diode Characteristic	s						
Drain-Source Diode Forward Voltage		V _{SD}	$V_{GS}=0V, I_{SD}=80A$		0.9	1.2	V
Reverse Recovery Time		t _{rr}	$I_{SD}=40AV_{GS}=0V$		44	88	ns
Reverse Recovery Charge		Qrr	di/dt=100A/us		77	154	nC
Notes:							

Electrical Characteristics(T_J= 25 °C, unless otherwise specified)

1. Pulse width $\leq 380 \mu s$; duty cycle $\leq 2\%$.

2. Repetitive rating; pulse width limited by max junction temperature.

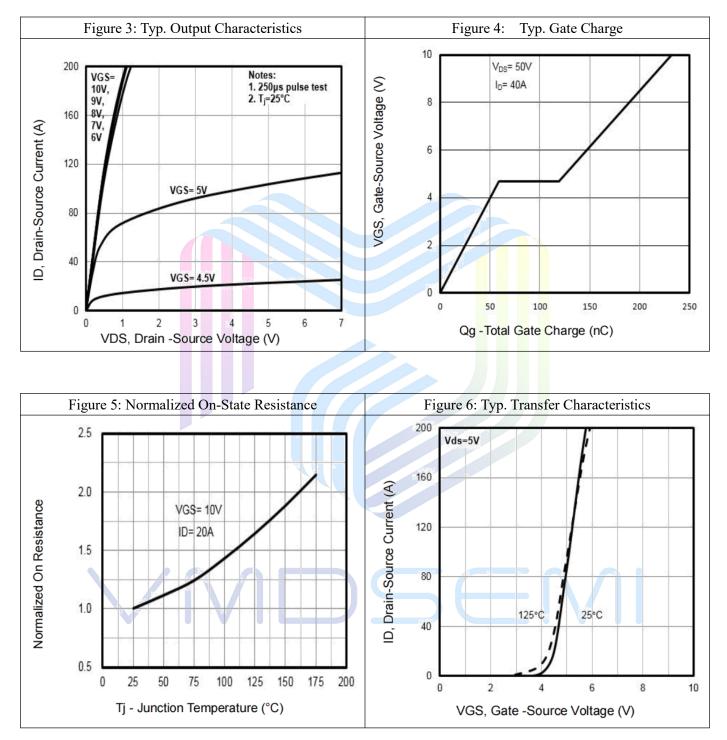
3. The power dissipation P_{DSM} is based on $R_{\theta JA}$ and $@T_J=150^{\circ}C$.

4. Limited by T_{Jmax} , starting $T_J = 25^{\circ}C$, L = 0.5mH, $R_G = 25\Omega$, $I_{AS} = 60A$, $V_{GS} = 10V$.



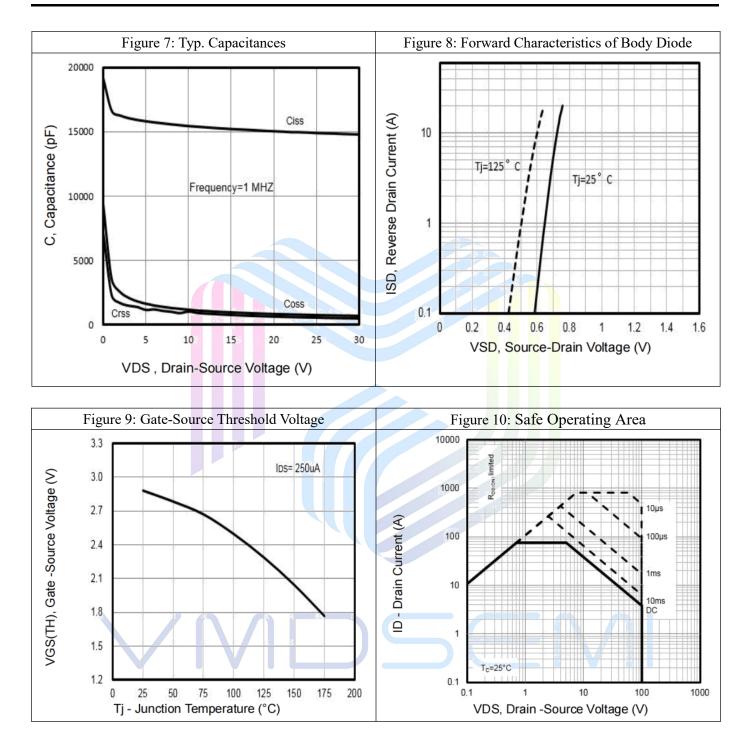
VUTS010R055NA

Typical Performance Characteristics



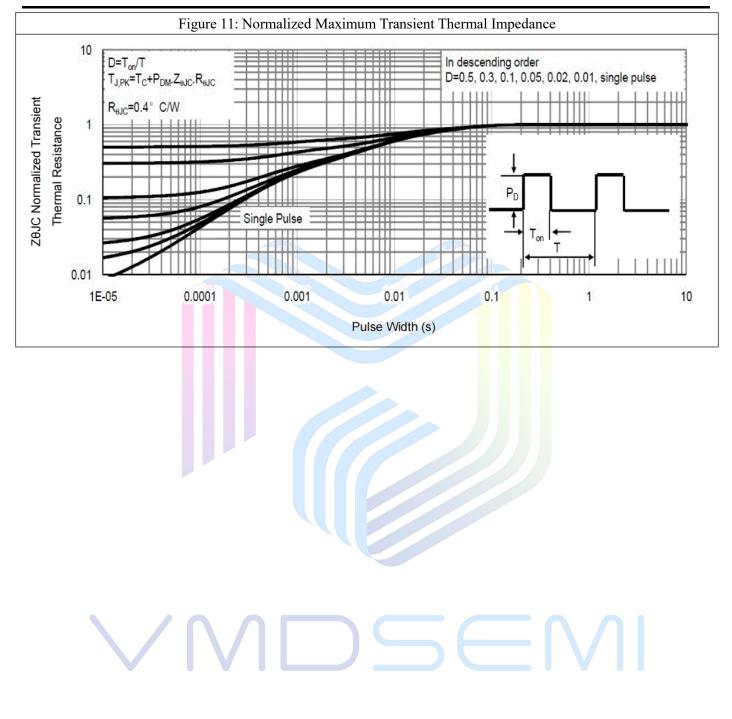


VUTS010R055NA





VUTS010R055NA

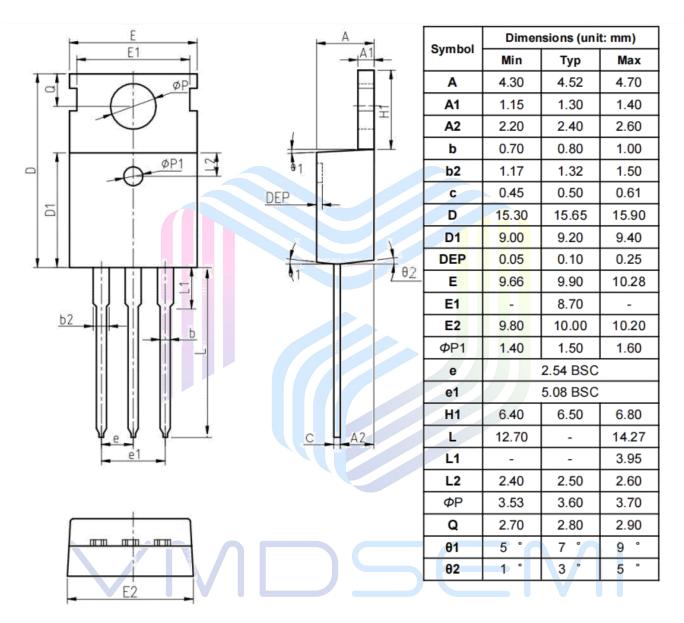




VUTS010R055NA

Mechanical Dimensions

Package Information TO-220AB



Notes:

- 1. Refer to JEDEC TO-220 variation AB
- 2. Dimension "D" and "E" do NOT include mold flash. Mold flash shall not exceed 0.127mm per side.



VUTS010R055NA

NOTICE

Hangzhou VMD Semiconductor Co., Ltd (VMD) reserves the right to make changes without notice in order to improve reliability, function or design and to discontinue any product or service without notice. Customers should obtain the latest relevant information before orders and should verify that such information is current and complete. All products are sold subject to VMD's terms and conditions supplied at the time of order acknowledgement.

VMD, its affiliates, agents, and employees, and all persons acting on its or their behalf, disclaim any and all liability for any errors, inaccuracies or incompleteness contained herein or in any other disclosure relating to any product.

VMD disclaims any and all liability arising out of the use or application of any product described herein or of any information provided herein to the maximum extent permitted by law. The product specifications do not expand or otherwise modify VMD's terms and conditions of purchase, including but not limited to the warranty expressed therein, which apply to these products.

VMD warrants performance of its hardware products to the specifications at the time of sale, testing, reliability and quality control are used to the extent VMD deems necessary to support this warrantee. Except where agreed upon by contractual agreement, testing of all parameters of each product is not necessarily performed.

VMD does not assume any liability arising from the use of any product or circuit designs described herein. Customers are responsible for their products and applications using VMD's components. To minimize risk, customers must provide adequate design and operating safeguards.

VMD does not warrant or convey any license to any intellectual property rights either expressed or implied under its patent rights, nor the rights of others. Reproduction of information in VMD's data sheets or data books is permissible only if reproduction is without modification or alteration. Reproduction of this information with any alteration is an unfair and deceptive business practice.

VMD is not responsible or liable for such altered documentation. Resale of VMD's products with statements different from or beyond the parameters stated by VMD for that product or service voids all express or implied warrantees for the associated VMD product or service and is an unfair and deceptive business practice.

All Rights Reserved.

VMD5EMI



Via-Media Semiconductor Limited Company

http://www.vmdsemi.com

Main Sites:

- Headquarters

Hangzhou Via-Media Semiconductor Co., LTD. 1305-1306, Building 71, No. 90, Wensan Road, Xihu District, Hangzhou, Zhejiang Province, P.R. China Tel: +86-0571-8515 0563

- Shanghai

Shanghai R&D Center. 1506~1508, Xinyin Building, 888 Yishan Road, Shanghai, P.R of China Tel: +86-021-54201999

- Xi'an

Xi'an R&D Center 1703B, Building A, Greenland Center, Jinye Road, High-Tech Zone, Xi'an, Shaanxi, P.R of China

- Chengdu Office

Chengdu Winhi Semiconductor Co., LTD. Floor 15, Building 5, No. 171, Hele 2nd Street, Chengdu, Sichuan Province, P.R. China Tel: +86-028-8505 0771

- Shenzhen

Shenzhen Sales officeRoom 4A15, Block AB, Tianxiang Building,Chegongmiao , Futian District, Shenzhen, P.R of ChinaTel: +86-0755-82570682